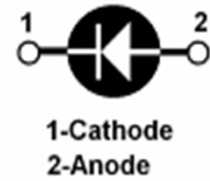
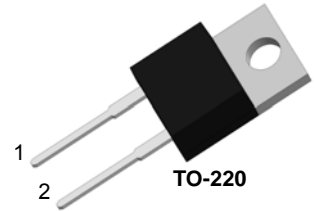


PRODUCT FEATURES

- Ultrafast Recovery Time
- Low Recovery Loss
- Soft Reverse Recovery Characteristics
- Low Leakage Current
- Low Forward Voltage
- High Surge Current Capability

APPLICATIONS

- Freewheeling, Snubber, Clamp
- Inversion Welder
- PFC
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- UPS



DESCRIPTION

FRED from MacMic utilizes advanced processing techniques to achieve ultrafast recovery times and higher forward current. Its soft recovery characteristics and high reliability suit for wide industrial applications.

ABSOLUTE MAXIMUM RATINGS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
V_R	Maximum D.C. Reverse Voltage		700	V
V_{RRM}	Maximum Repetitive Reverse Voltage			
$I_{F(AV)}$	Average Forward Current	$T_C=110^{\circ}\text{C}$, Per Diode	15	A
$I_{F(RMS)}$	RMS Forward Current	$T_C=110^{\circ}\text{C}$, Per Diode	21	
I_{FSM}	Non-Repetitive Surge Forward Current	$T_J=45^{\circ}\text{C}$, $t=10\text{ms}$, 50Hz, Sine	150	
P_D	Power Dissipation		83	W
T_J	Junction Temperature		-55 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range		-55 to +150	$^{\circ}\text{C}$
Torque	Module-to-Sink	Recommended (M3)	1.1	N•m
$R_{th(J-C)}$	Junction-to-Case Thermal Resistance		1.5	$^{\circ}\text{C}/\text{W}$
Weight			2.5	g

ELECTRICAL CHARACTERISTICS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
I_{RM}	Maximum Reverse Leakage Current				10	μA
					10	mA
V_F	Forward Voltage			1.3	1.6	V
				1.15		
trr	Reverse Recovery Time ($I_F = 1\text{A}$, $di_F/dt = -200\text{A}/\mu\text{s}$, $V_R = 30\text{V}$)			21		ns
trr	Reverse Recovery Time			170		ns
I_{RRM}	Maximum Reverse Recovery Current			4		A
trr	Reverse Recovery Time			225		ns
I_{RRM}	Maximum Reverse Recovery Current			7.2		A
S				3.5		

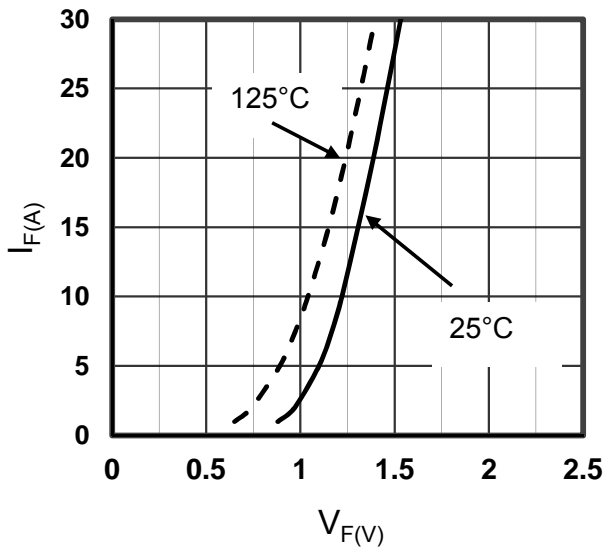


Figure1. Forward Voltage Drop vs Forward Current

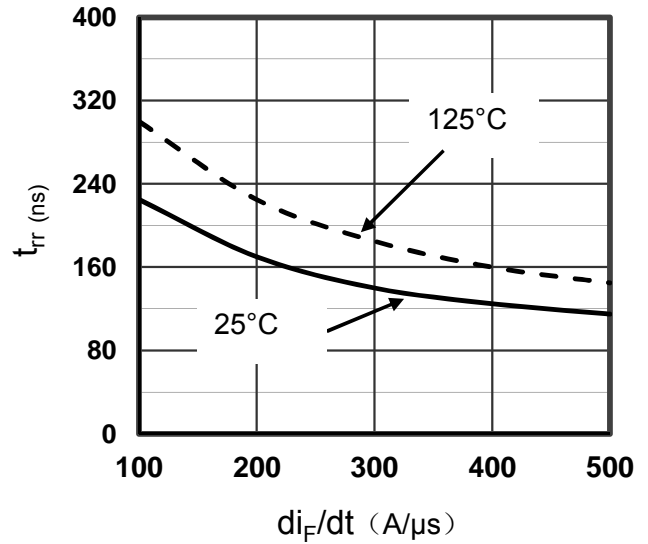


Figure2. Reverse Recovery Time vs diF/dt

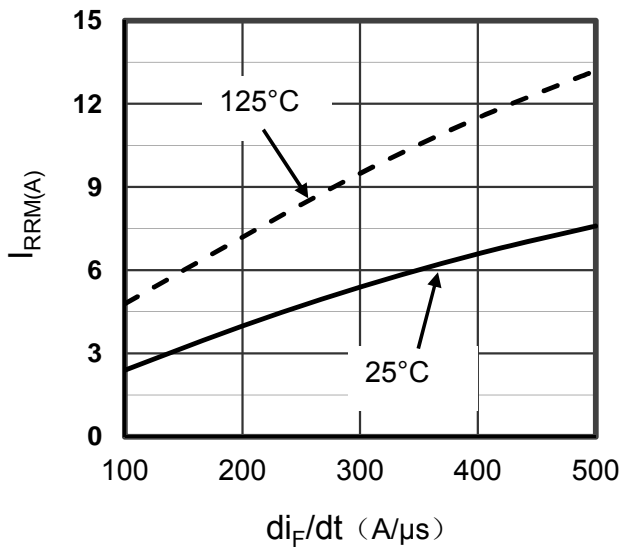


Figure3. Reverse Recovery Current vs diF/dt

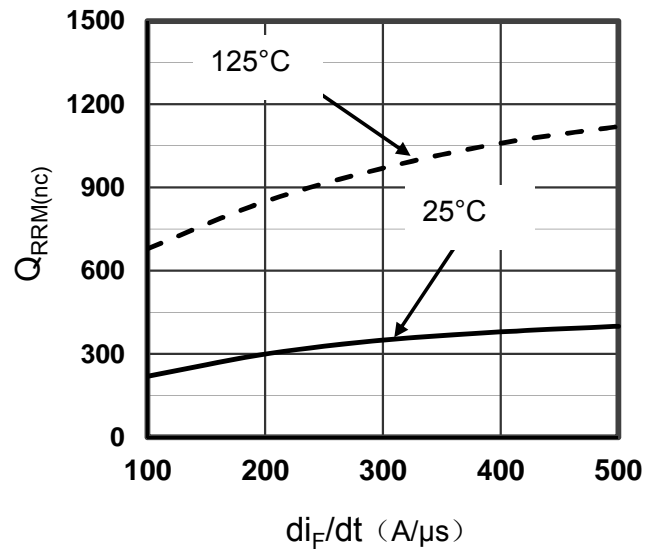


Figure4. Reverse Recovery Charge vs diF/dt

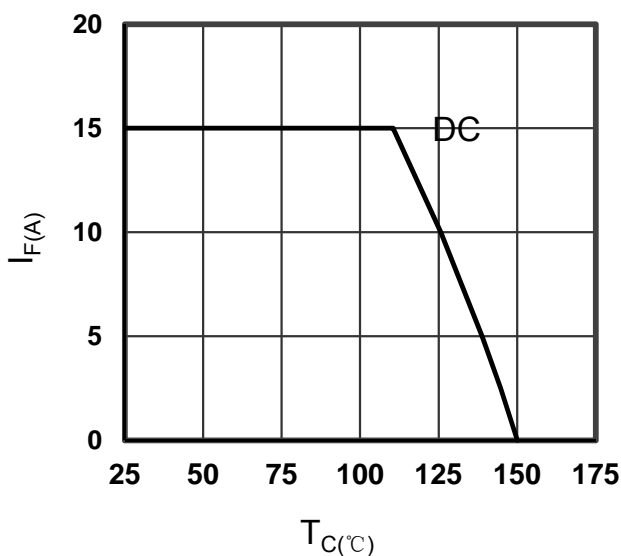


Figure5. Forward current vs Case temperature

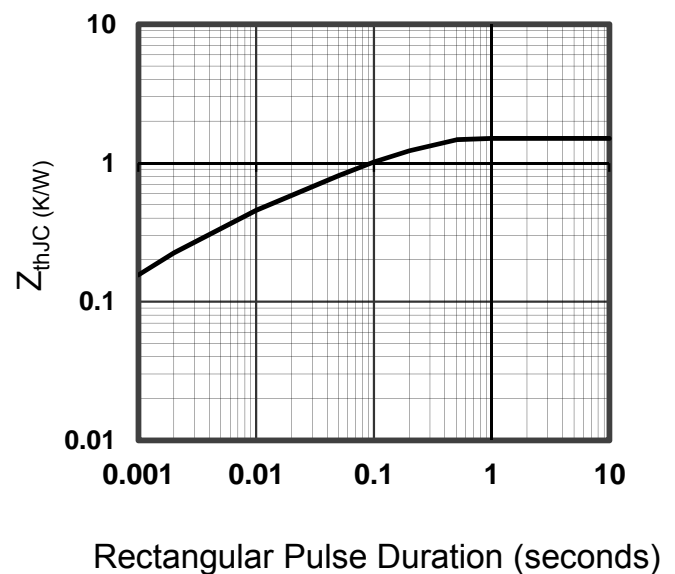


Figure6. Transient Thermal Impedance

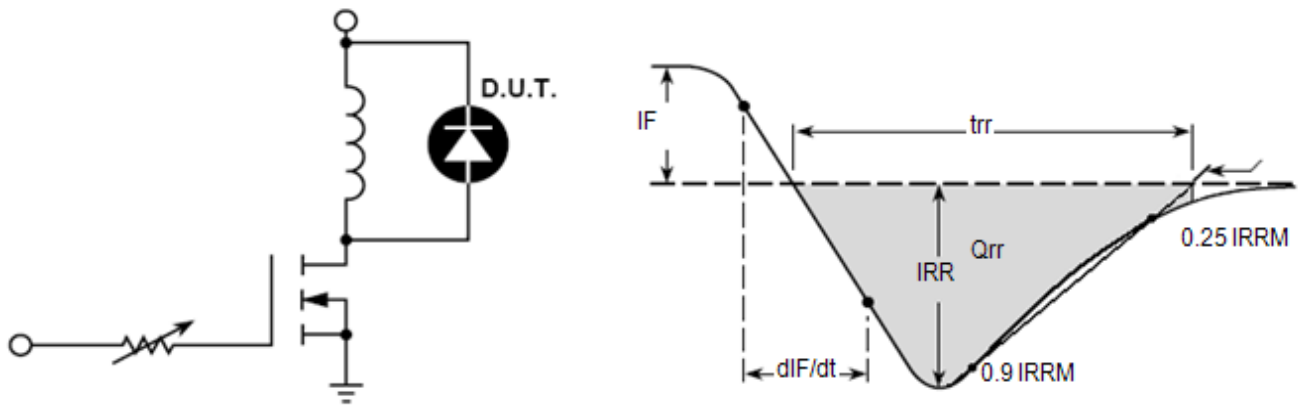
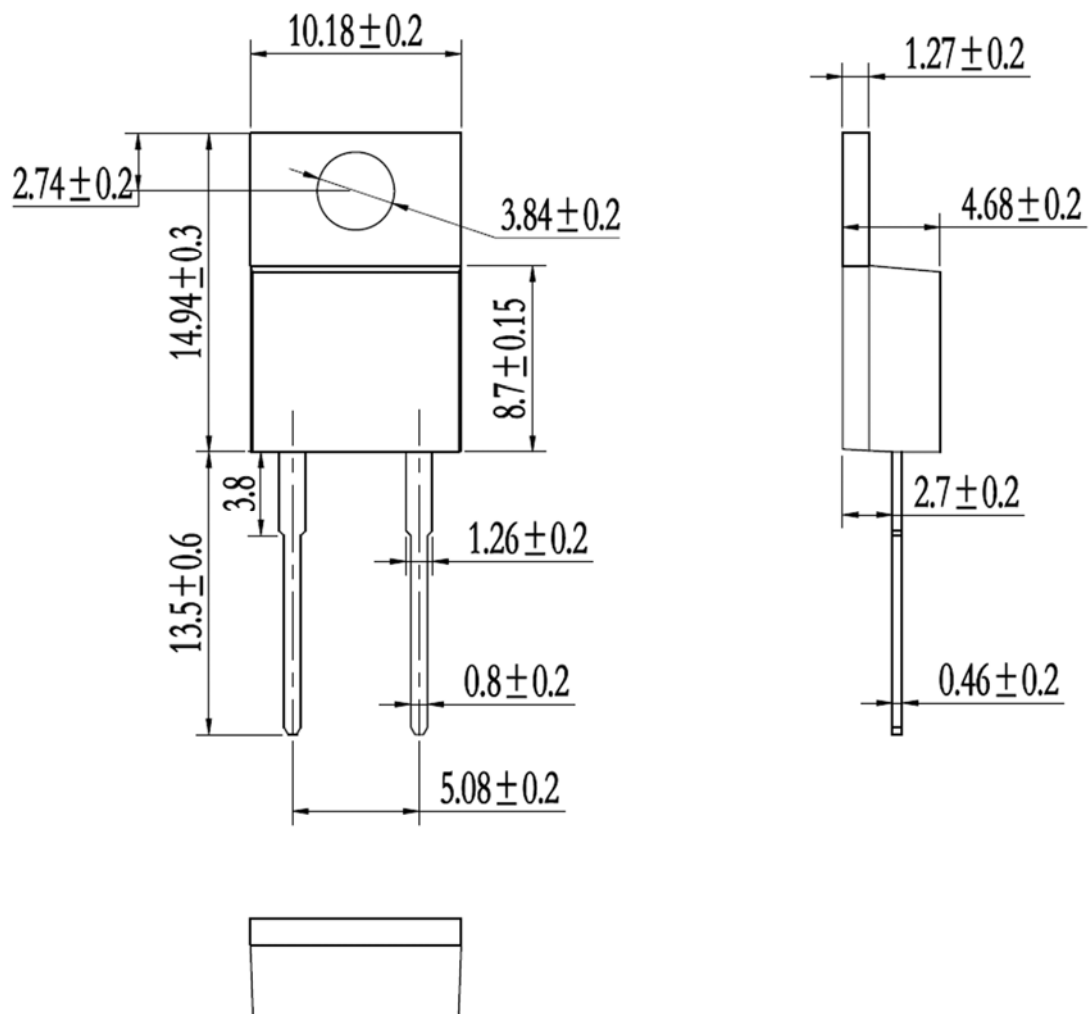


Figure7. Diode Reverse Recovery Test Circuit and Waveform



Dimensions in Millimeters
Figure8. Package Outline